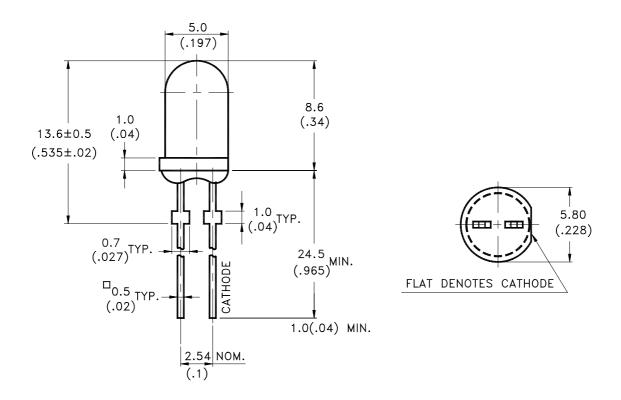


Features

- * High luminous intensity output.
- * Low power consumption.
- * High efficiency.
- * Versatile mounting on P.C. board or panel.
- * I.C. Compatible/ low current requirements.
- * Popular 5mm (.179) diameter.

Package Dimensions



Part No.	Lens	Source Color
LTL2U7SEK-002A	Water Clear	TS AlInGaP Red

Notes:

- 1. All dimensions are in millimeters (inches).
- 7 Tolerance is ± 0.25 mm(.010") unless otherwise noted.
- 3. Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.

Part No.: LTL2U7SEK-002A Page: 1 of 8



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Absolute Maximum Ratings at TA=25℃

Parameter	Maximum Rating Unit	
Power Dissipation	130 mW	
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	100 mA	
DC Forward Current	50	mA
Derating Linear From 50°C	0.6 mA/°	
Reverse Voltage	5 V	
Operating Temperature Range	-40°C to + 80°C	
Storage Temperature Range	-55°C to + 100°C	
Lead Soldering Temperature [1.6mm(.063") From Body]	260°C for 5 Seconds	

Part No.: LTL2U7SEK-002A Page: 2 of 8



Electrical / Optical Characteristics at TA=25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	Iv	1900	4200		mcd	I _F = 20mA Note 1
Viewing Angle	$2\theta_{1/2}$		30		deg	Note 2 (Fig.5)
Peak Emission Wavelength	λр		639		nm	Measurement @Peak (Fig.1)
Dominant Wavelength	$\lambda_{ m d}$		630		nm	Note 3
Spectral Line Half-Width	Δλ		17		nm	
Forward Voltage	V_{F}		2.25	2.7	V	$I_F = 20 \text{mA}$
Reverse Current	I_R			100	μΑ	$V_R = 5V$
Capacitance	С		40		pF	$V_F = 0$, $f = 1MHz$

NOTE: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

- 2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength, λd is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

Part No.: LTL2U7SEK-002A Page: 3 of 8

Typical Electrical / Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

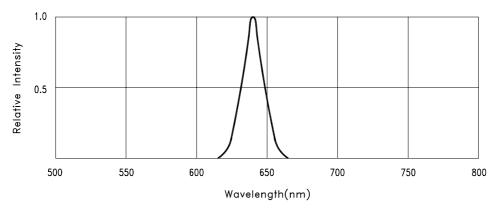
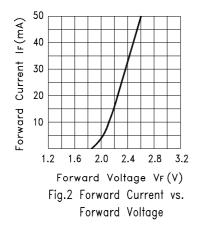
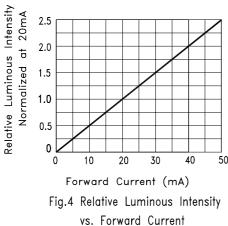
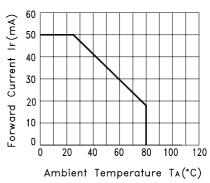


Fig.1 Relative Intensity vs. Wavelength







Ambient Temperature Ta(°C)
Fig.3 Forward Current
Derating Curve

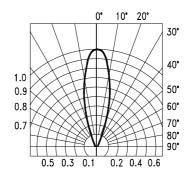


Fig.5 Spatial Distribution

Part No.: LTL2U7SEK-002A Page: 4 of 8



CAUTIONS

1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity.

It is recommended that LEDs out of their original packaging are used within three months.

For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant or in desiccators with nitrogen ambient.

3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LEDs if necessary.

4. Lead Forming & Assembly

During lead forming, the leads should be bent at a point at least 3mm from the base of LED lens.

Do not use the base of the lead frame as a fulcrum during forming.

Lead forming must be done before soldering, at normal temperature.

During assembly on PCB, use minimum clinch force possible to avoid excessive mechanical stress.

5. Soldering

When soldering, leave a minimum of 2mm clearance from the base of the lens to the soldering point. Dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

Solder	ng iron	Wave soldering	
Temperature Soldering time	300°C Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat time Solder wave Soldering time	100°C Max. 60 sec. Max. 260°C Max. 10 sec. Max.

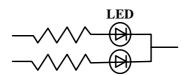
Note: Excessive soldering temperature and/or time might result in deformation of the LED lens or catastrophic failure of the LED

Part No.: LTL2U7SEK -002A Page: 5 of 8

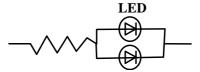
6. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.

Circuit model A



Circuit model B



- (A) Recommended circuit
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs

7. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use a conductive wrist band or anti- electrostatic glove when handling these LEDs
- All devices, equipment, and machinery must be properly grounded
- Work tables, storage racks, etc. should be properly grounded
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing

ESD-damaged Leeds will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no light up" at low currents. To verify for ESD damage, check for "light up" and Vf of the suspect LEDs at low currents.

The Vf of "good" LEDs should be >2.0V@0.1mA for InGaN product and >1.4V@0.1mA for AlInGaP product.

Chip ESD level	Machine Model	Human Body Model
InGaN / Sapphire	100 V	300 V
AlInGaP	200 V	500 V
InGaN / SiC	600 V	1000 V

Part No.: LTL2U7SEK-002A Page: 6 of 8

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Suggested checking list:

Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DSL?
- 5. All wrist strap or heel strap checkers calibration up to date? Note: *50V for Blue LED.

Device Handling

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycle?

Others

- 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?

Part No.: LTL2U7SEK-002A Page: 7 of 8



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8. Reliability Test

Classification	Test Item	Test Condition	Reference Standard
	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-750D:1026 (1995) MIL-STD-883D:1005 (1991) JIS C 7021:B-1 (1982)
	High Temperature High Humidity Storage	Ta= $65\pm5^{\circ}$ C RH= $90 \sim 95\%$ Test Time= 240 HRS ±2 HRS	MIL-STD-202F: 103B(1980) JIS C 7021 : B-11(1982)
Endurance Test	High Temperature High Humidity Reverse BIAS	Ta= $65\pm5^{\circ}$ C RH= $90 \sim 95\%$ VR=5V Test Time = 500 HRS (-24HRS, +48HRS)	
	High Temperature Storage	Ta= 105±5°C *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 (1991) JIS C 7021:B-10 (1982)
	Low Temperature Storage	Ta= -55±5°C *Test Time=1000HRS (-24HRS,+72HRS)	JIS C 7021:B-12 (1982)
	Temperature Cycling	$105^{\circ}\text{C} \sim 25^{\circ}\text{C} \sim -55^{\circ}\text{C} \sim 25^{\circ}\text{C}$ 30mins 5mins 30mins 5mins 10 Cycles	MIL-STD-202F:107D (1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1010 (1991) JIS C 7021: A-4(1982)
Environmental	Thermal Shock	$105 \pm 5^{\circ}$ C $\sim -55^{\circ}$ C $\pm 5^{\circ}$ C 10 mins 10 Cycles	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1011 (1991)
Test Solder $T.sol = 260 \pm 5^{\circ}C$ Resistance Dwell Time= $10 \pm 10^{\circ}C$		T.sol = $260 \pm 5^{\circ}$ C Dwell Time= 10 ± 1 secs	MIL-STD-202F:210A(1980) MIL-STD-750D:2031(1995) JIS C 7021: A-1(1982)
	Solderability		MIL-STD-202F:208D(1980) MIL-STD-750D:2026(1995) MIL-STD-883D:2003(1991) JIS C 7021: A-2(1982)

9. Others

The appearance and specifications of the product may be modified for improvement, without prior notice.

Part No.: LTL2U7SEK-002A Page: 8 of 8
